



650V Super-Junction Power MOSFET

Description

650V Super-junction Power MOSFET

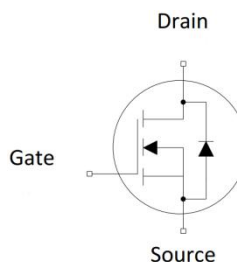
Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle and pioneered. The Multi-EPI SJ MOSFET provide an extremely fast and robust body diode. Also provide an extremely low switching, communication and conduction losses device with highest robustness make especially resonant switching applications more reliable, more efficient, lighter and cooler, also fits the industrial grade applications,like AC-DC SMPS requirements for PFC, AC/DC power conversion, designed by Wuxi Unigroup Microelectronics Company.

Features

- Ultra-fast body diode
- Very low FOM $R_{DS(on)} \times Q_g$
- Easy to use/drive
- 100% avalanche tested
- RoHS compliant

Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- LLC Half-bridge
- Charger



Device Marking and Package Information

Device	Package	Marking
TPA65R100MFD	TO-220F	65R100MFD
TPV65R100MFD	TO-3PN	65R100MFD
TPW65R100MFD	TO-247	65R100MFD

Key Performance Parameters

Parameter	Value	Unit
$V_{DS} @ T_{j,max}$	700	V
$R_{DS(on),max}$	0.1	Ω
$Q_{g,typ}$	75	nC
I_D	47	A
$I_{D,pulse}$	141	A
$E_{OSS} @ 400V$	8.98	μJ
Body Diode di_f/dt	500	A/ μs
t_{rr}	145	ns
Q_{rr}	0.87	μC
I_{rrm}	12	A



Absolute Maximum Ratings $T_C = 25^{\circ}\text{C}$, unless otherwise noted				
Parameter		Symbol	Value	Unit
Continuous Drain Current	$T_C = 25^{\circ}\text{C}$	I_D	47	A
	$T_C = 100^{\circ}\text{C}$		28.2	
Pulsed Drain Current	(note1)	$I_{D,pulse}$	141	A
Gate-Source Voltage		V_{GSS}	± 30	V
Single Pulse Avalanche Energy	(note2)	E_{AS}	1160	mJ
Repetitive Avalanche Energy	(note2)	E_{AR}	1.76	mJ
Avalanche Current		I_{AR}	8.7	A
MOSFET dv/dt Ruggedness, $V_{DS} = 0 \dots 480\text{V}$		dv/dt	50	V/ns
Power Dissipation For TO-220F		P_D	37	W
Power Dissipation For TO-3PN,TO-247			391	
Continuous Diode Forward Current		I_S	47	A
Diode Pulsed Current	(note1)	$I_{S,pulse}$	141	
Reverse Diode dv/dt	(note3)	dv/dt	50	V/ns
Maximum Diode Commutation Speed	(note3)	di/dt	900	A/ μs
Operating Junction and Storage Temperature Range		T_J, T_{stg}	$-55 \sim +150$	$^{\circ}\text{C}$

Thermal Resistance For TO-220F			
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	R_{thJC}	3.37	$^{\circ}\text{C/W}$
Thermal Resistance, Junction-to-Ambient	R_{thJA}	80	

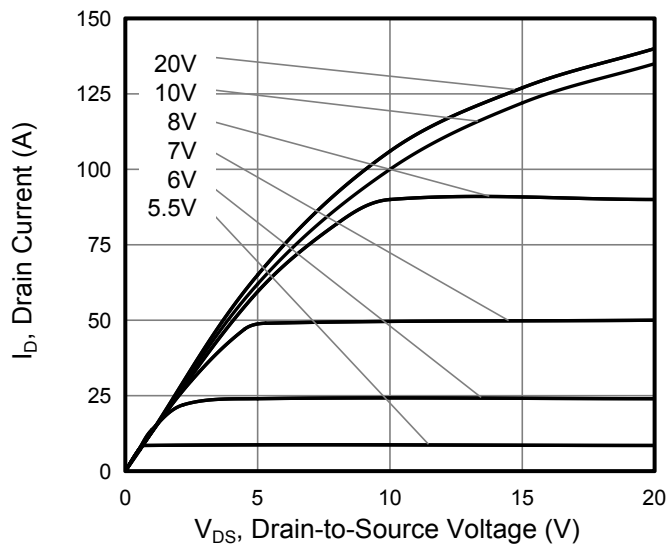
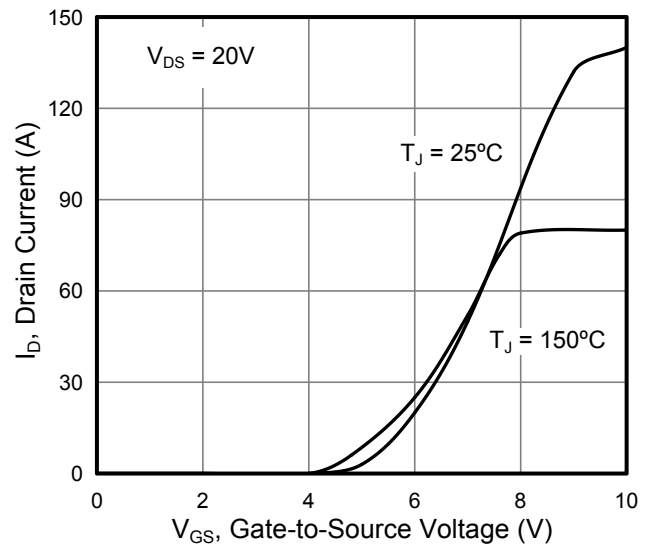
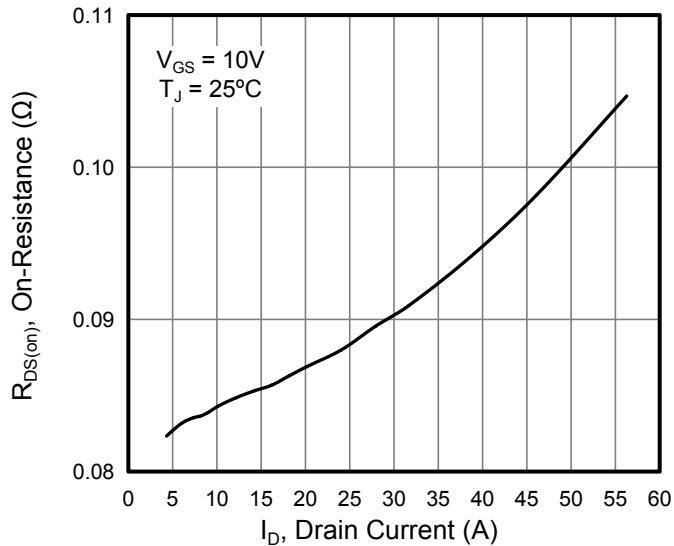
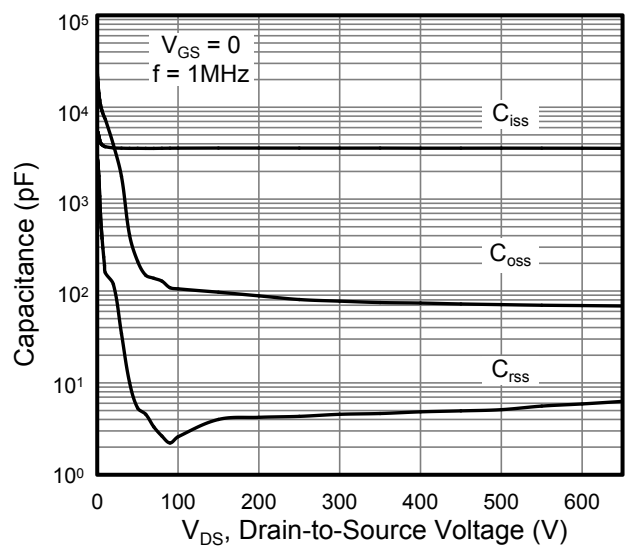
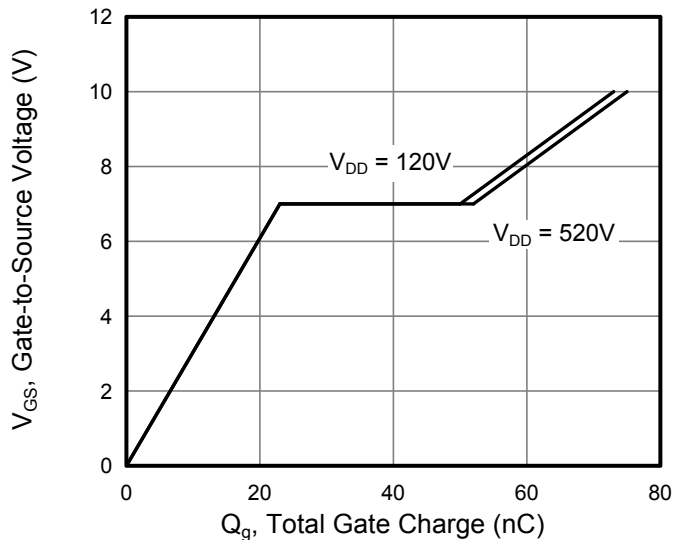
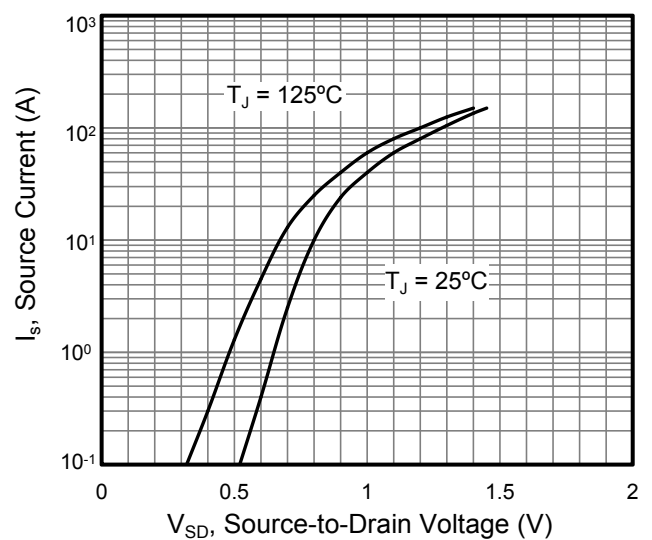
Thermal Resistance For TO-3PN,TO-247			
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	R_{thJC}	0.32	$^{\circ}\text{C/W}$
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62	



Electrical Characteristics T _J = 25°C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	650	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 650V, V _{GS} = 0V, T _J = 25°C	--	--	5	μA
		V _{DS} = 650V, V _{GS} = 0V, T _J = 150°C	--	--	5000	
Gate-Source Leakage Current	I _{GSS}	V _{GS} = ±30V	--	--	±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	3	--	5	V
Drain-Source On-State-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 24A	--	0.088	0.1	Ω
Gate Resistance	R _G	f = 1.0MHz open drain	--	0.8	--	Ω
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 100V, f = 1.0MHz	--	3587	--	pF
Output Capacitance	C _{oss}		--	106	--	
Reverse Transfer Capacitance	C _{rss}		--	2.6	--	
Total Gate Charge	Q _g	V _{DD} = 520V, I _D = 47A, V _{GS} = 10V	--	78	--	nC
Gate-Source Charge	Q _{gs}		--	24	--	
Gate-Drain Charge	Q _{gd}		--	32	--	
Turn-on Delay Time	t _{d(on)}	V _{DD} = 400V, I _D = 47A, R _G = 25Ω	--	49	--	ns
Turn-on Rise Time	t _r		--	123	--	
Turn-off Delay Time	t _{d(off)}		--	105	--	
Turn-off Fall Time	t _f		--	49	--	
Drain-Source Body Diode Characteristics						
Body Diode Forward Voltage	V _{SD}	T _J = 25°C, I _{SD} = 24A, V _{GS} = 0V	--	1.0	1.5	V
Reverse Recovery Time	t _{rr}	V _R = 400V, I _F = 23A, di _F /dt = 100A/μs	--	145	--	ns
Reverse Recovery Charge	Q _{rr}		--	0.87	--	μC
Peak Reverse Recovery Current	I _{rrm}		--	12	--	A

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. $I_{AS} = 8.7A, V_{DD} = 50V, R_G = 25\Omega$, Starting $T_J = 25^{\circ}\text{C}$
3. Identical low side and high side switch with identical R_G

**Typical Characteristics** $T_J = 25^\circ\text{C}$, unless otherwise noted**Figure 1. Output Characteristics****Figure 2. Transfer Characteristics****Figure 3. On-Resistance vs. Drain Current****Figure 4. Capacitance****Figure 5. Gate Charge****Figure 6. Body Diode Forward Voltage**



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. On-Resistance vs. Junction Temperature

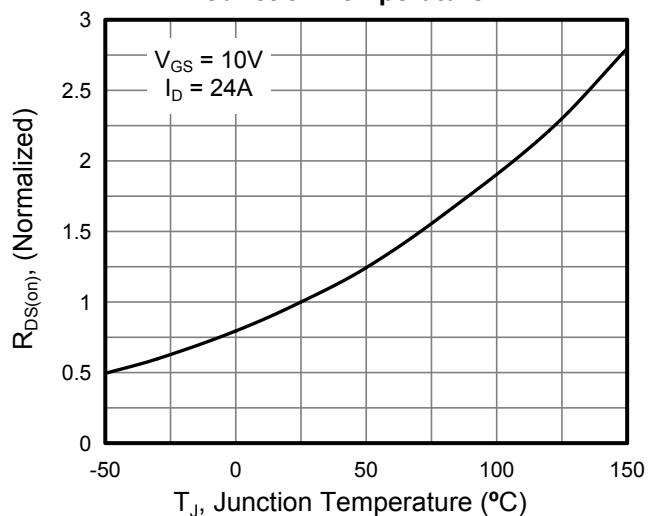


Figure 8. Breakdown voltage vs. Junction Temperature

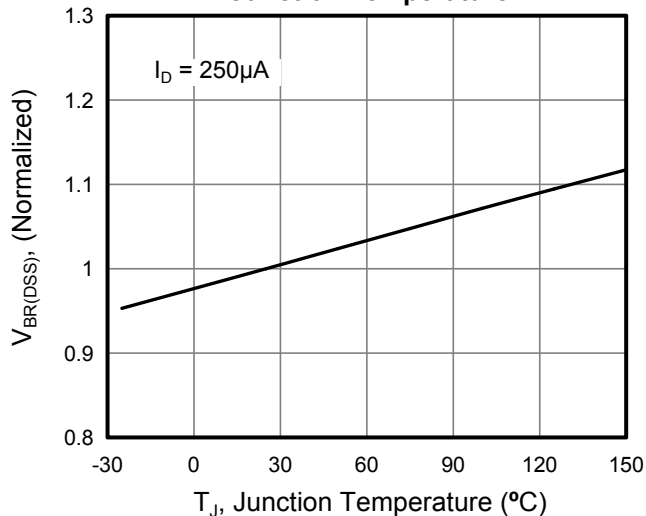


Figure9 . Transient Thermal Impedance For TO-220F

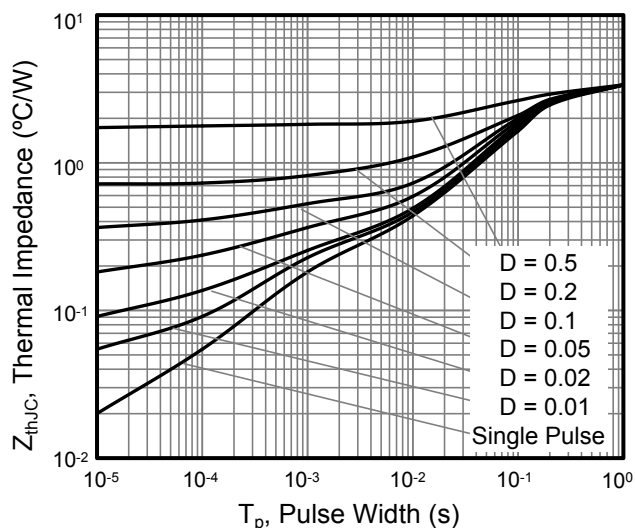


Figure10 . Transient Thermal Impedance For TO-3PN/TO-247

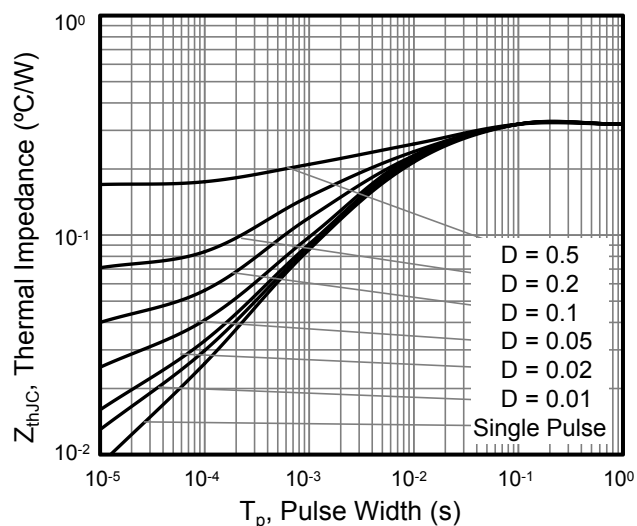


Figure 11. Safe Operation Area For TO-220F

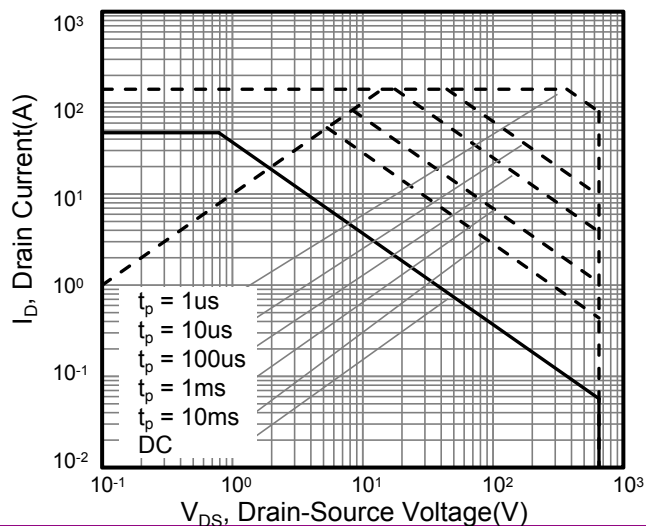
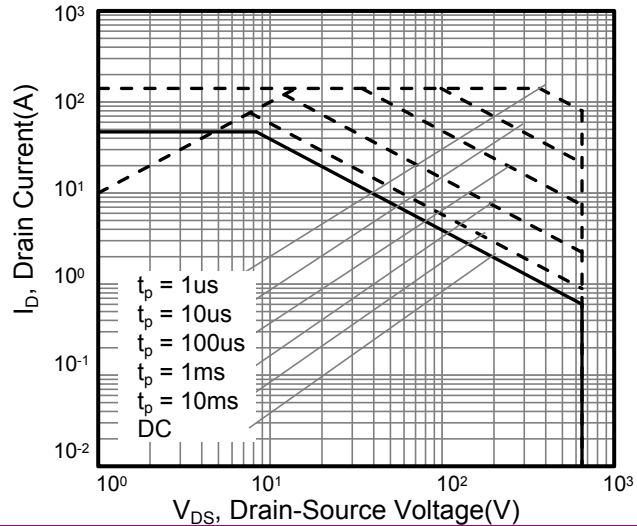


Figure 12. Safe Operation Area For TO-3PN/TO-247





Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Figure 13. Typ. Coss Stored Energy

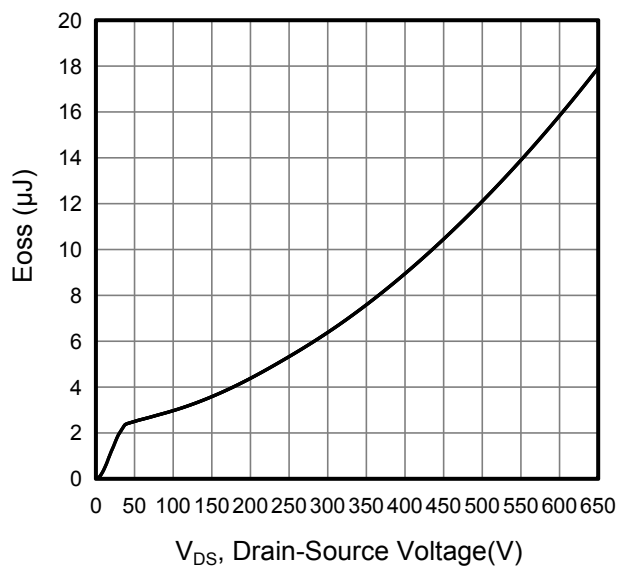




Figure A: Gate Charge Test Circuit and Waveform

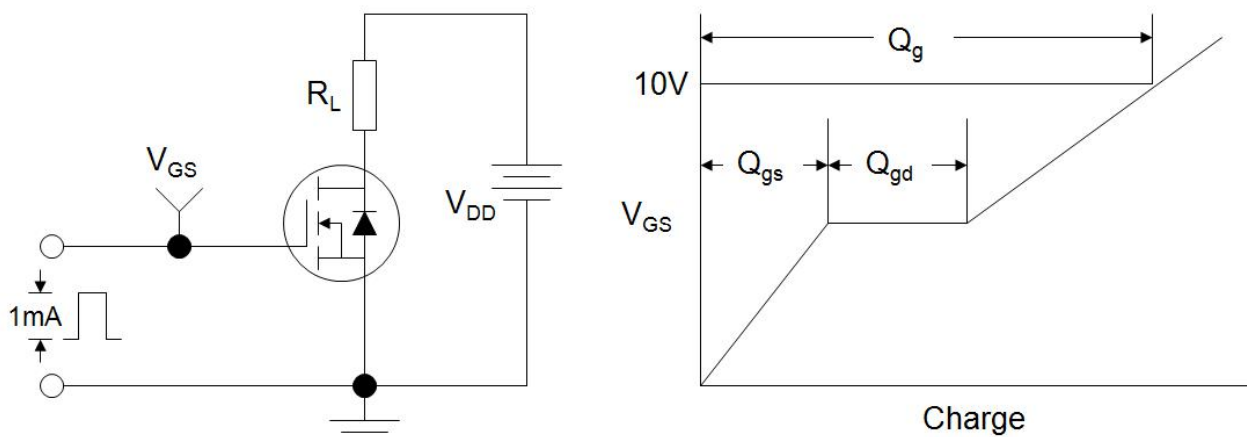


Figure B: Resistive Switching Test Circuit and Waveform

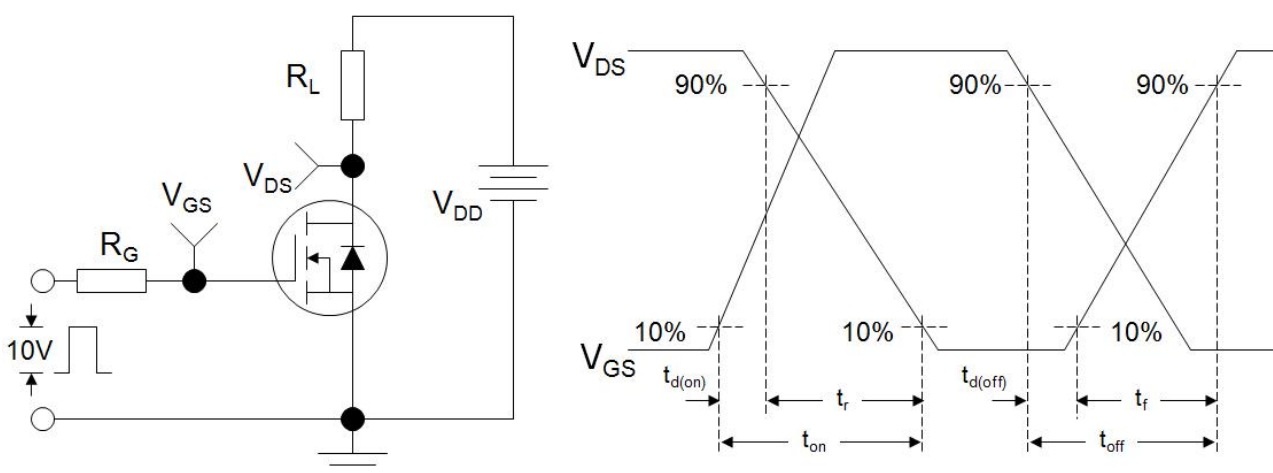
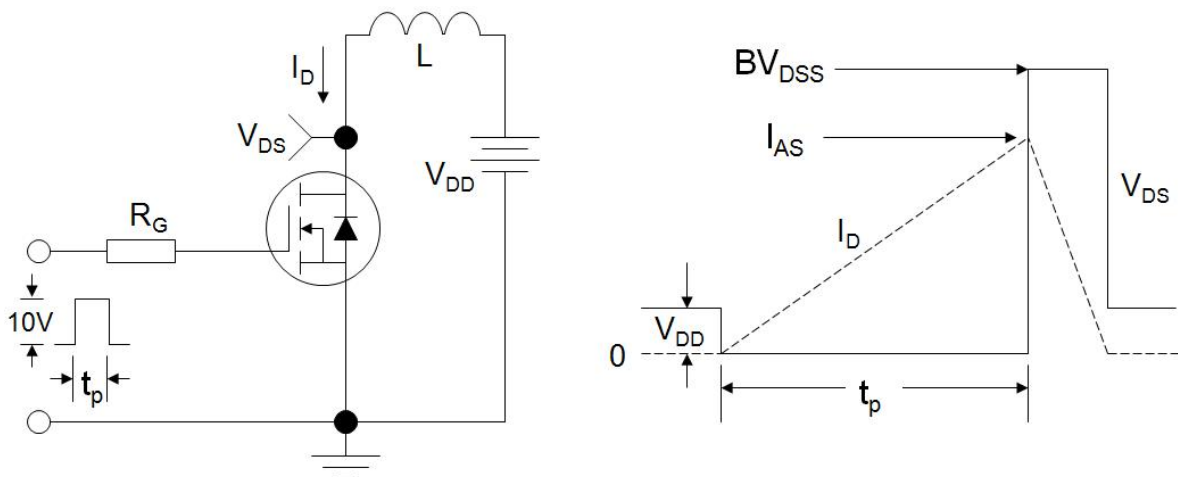
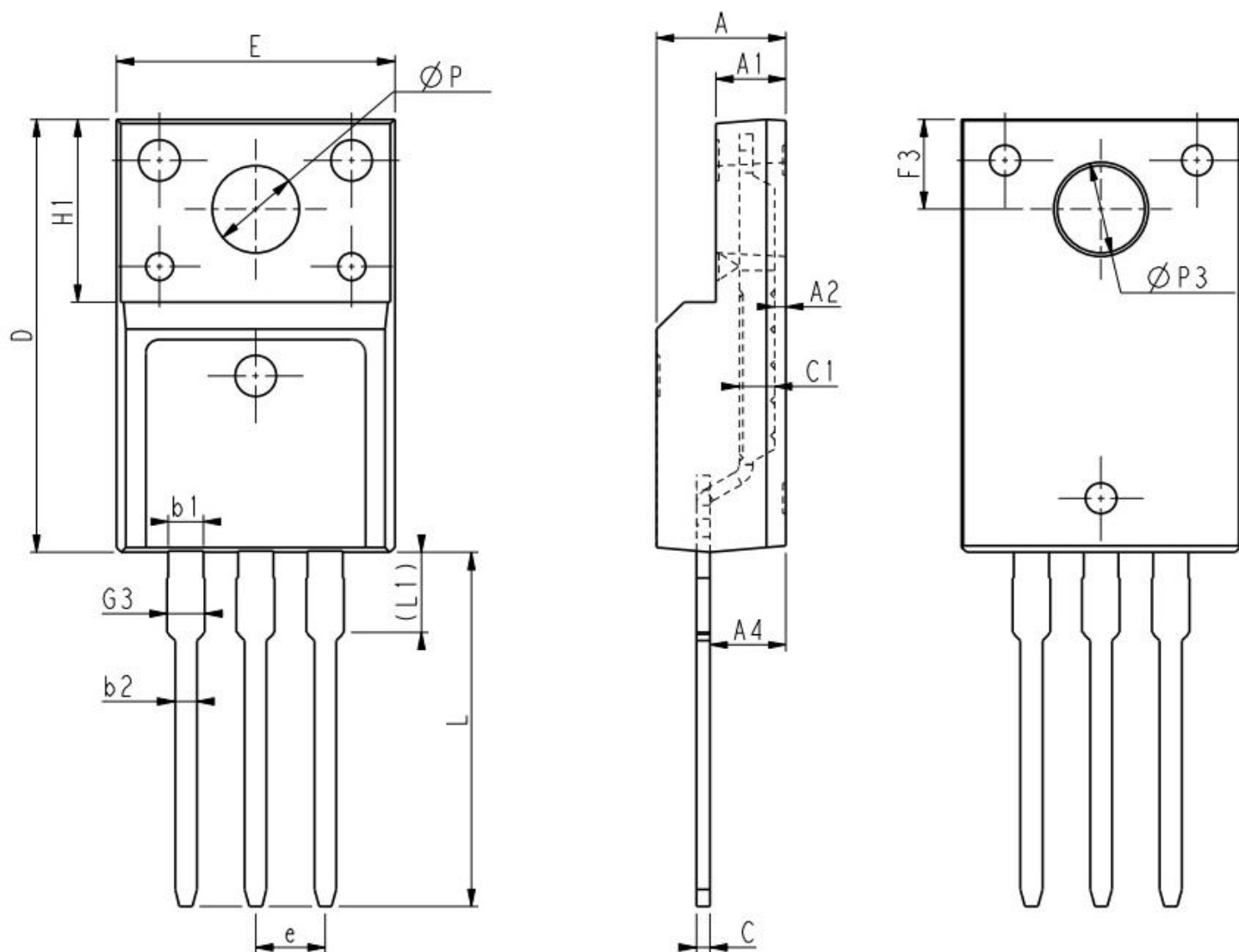


Figure C: Unclamped Inductive Switching Test Circuit and Waveform





TO-220F (华羿)

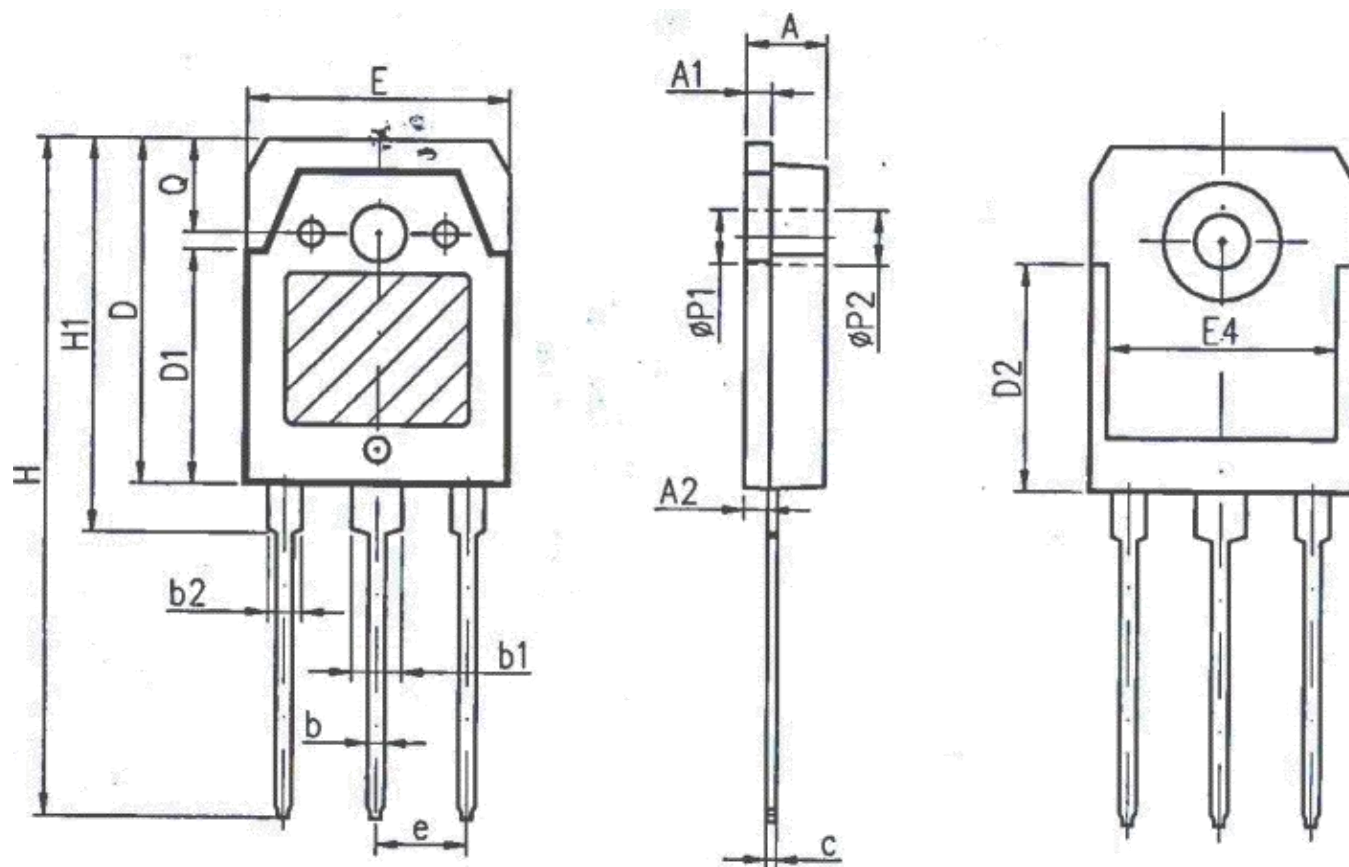


Unit:mm			
Symbol	Min.	Nom	Max.
E	9.96	10.16	10.36
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A2	0.30	0.45	0.60
A4	2.56	2.76	2.96
c	0.40	0.50	0.65
c1	1.20	1.30	1.35
D	15.57	15.87	16.17
H1	6.70REF		

Unit:mm			
Symbol	Min.	Nom	Max.
e	2.54BSC		
L	12.68	12.98	13.28
L1	2.93	3.03	3.13
ΦP	3.03	3.18	3.38
ΦP3	3.15	3.45	3.65
F3	3.15	3.30	3.45
G3	1.25	1.35	1.55
b1	1.18	1.28	1.43
b2	0.70	0.80	0.95



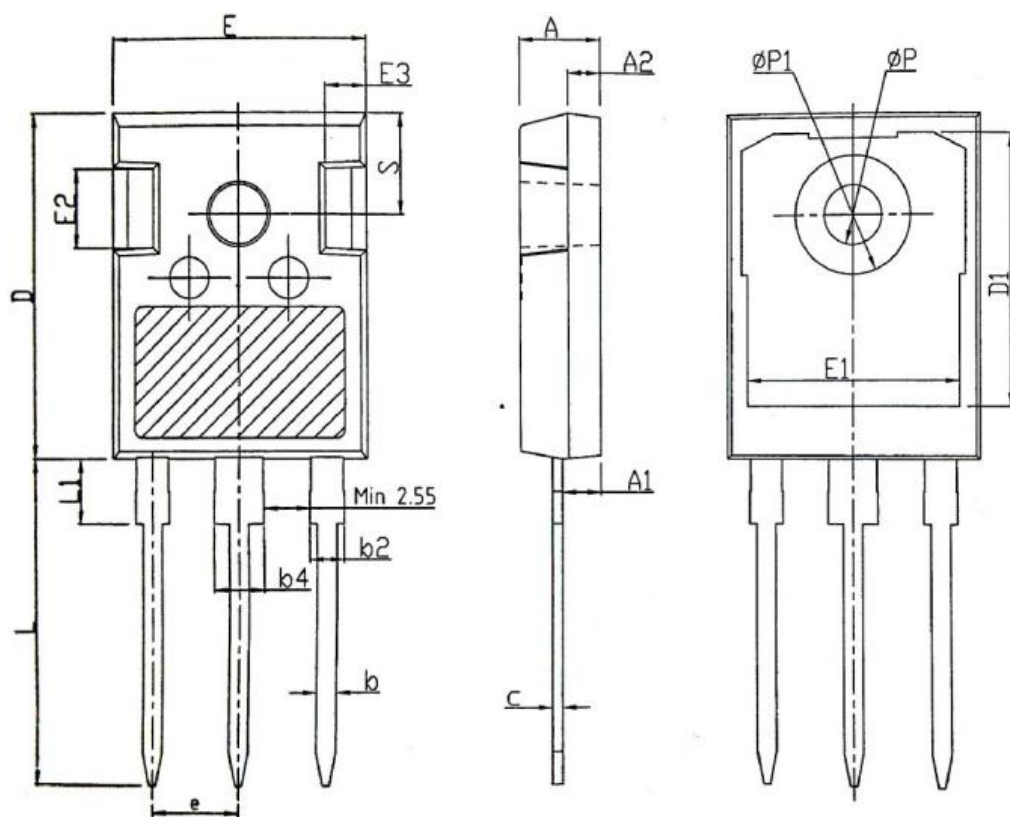
TO-3PN (华羿)



SYMBOL	mm		
	MIN	NOM	MAX
A	4.60	4.80	5.00
A1	1.40	1.50	1.65
A2	1.18	1.38	1.58
b	0.80	1.00	1.20
b1	2.80	3.00	3.20
b2	1.80	2.00	2.20
c	0.50	0.60	0.75
D	19.60	19.90	20.20
D1	13.55	13.90	14.25
D2	12.90 REF		
E	15.35	15.60	15.85
E4	12.60	-	-
e	5.45 TYP		
H	40.10	40.50	40.90
H1	23.15	23.40	23.65
ΦP1	3.20 REF		
ΦP2	3.50 REF		



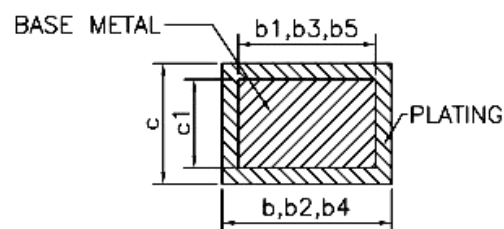
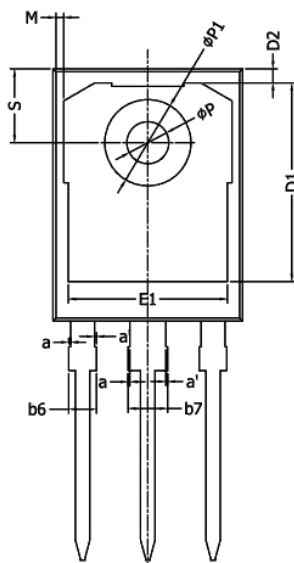
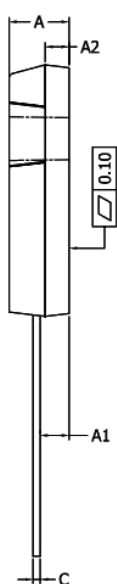
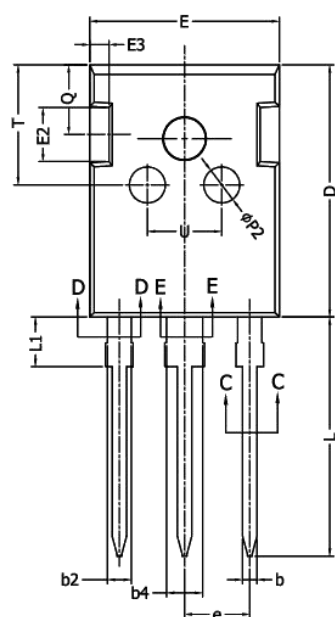
TO-247 (华羿)



SYMBOL	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.59
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
c	0.51	0.61	0.75
D	20.80	21.00	21.30
D1	16.25	16.55	16.85
E	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e	5.44BSC		
L	19.82	19.92	20.22
L1	-	-	4.30
ΦP	3.40	3.60	3.80
ΦP1	-	-	7.30
S	6.15BSC		



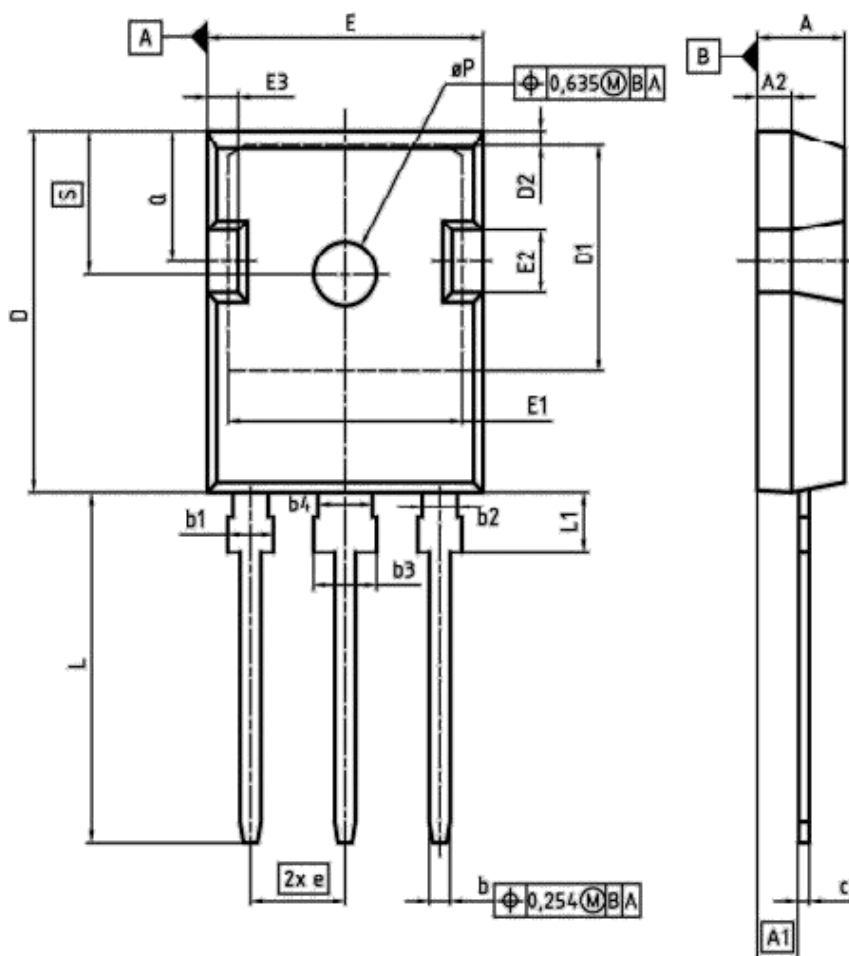
TO-247 (集佳)



SYMBOL	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
a	0	---	0.15
a'	0	---	0.15
b	1.16	---	1.26
b1	1.15	1.2	1.22
b2	1.96	---	2.06
b3	1.95	2.00	2.02
b4	2.96	---	3.06
b5	2.96	3.00	3.02
b6	---	---	2.25
b7	---	---	3.25
c	0.59	---	0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.17	1.35
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.40	4.50	4.60
E3	2.40	2.50	2.60
e	5.436 BSC		
L	19.80	19.92	20.10
L1	---	---	4.30
M	0.35	---	0.95
P	3.40	3.50	3.60
P1	7.00	---	7.40
P2	2.40	2.50	2.60
Q	5.60	---	6.00
S	6.05	6.15	6.25
T	9.80	---	10.20
U	6.00	---	6.40



TO-247 (封装厂 E)



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.27	2.54	0.089	0.100
A2	1.85	2.16	0.073	0.085
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695
D2	0.95	1.35	0.037	0.053
E	15.70	16.13	0.618	0.635
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.00	2.60	0.039	0.102
e	5.44 (BSC)		0.214 (BSC)	
N	3		3	
L	19.80	20.32	0.780	0.800
L1	4.10	4.47	0.161	0.176
ØP	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248



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